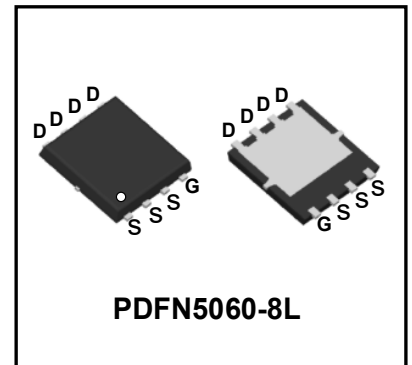


120V N-Channel Enhancement Mode Power MOSFET

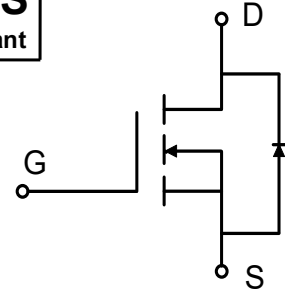
Description

WMB072N12HG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



Features

- $V_{DS} = 120V$, $I_D = 90A$
 $R_{DS(on)} < 7.5m\Omega @ V_{GS} = 10V$
- Green Device Available
- 100% EAS Guaranteed
- Optimized for High Speed Smooth Switching



Applications

- Power Management Switches
- DC/DC Converters

Absolute Maximum Ratings (T_c = 25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	120	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	T _c =25°C	90
		T _c =100°C	57
Pulsed Drain Current ⁴	I_{DM}	360	A
Single Pulse Avalanche Energy ³	EAS	168.2	mJ
Total Power Dissipation ⁴	P_D	104	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	56	°C/W
Thermal Resistance from Junction-to-Case	$R_{\theta JC}$	1.2	°C/W

Electrical Characteristics (Tc = 25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	120	-	-	V	
Gate-body Leakage Current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	$T_J=25^\circ C$	I_{DSS}	$V_{DS} = 120V, V_{GS} = 0V$	-	-	1	μA
	$T_J=100^\circ C$			-	-	100	
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V	
Drain-Source On-Resistance ²	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$	-	6	7.5	m Ω	
Forward Transconductance ²	g_{fs}	$V_{DS} = 5V, I_D = 20A$	-	87	-	S	
Dynamic Characteristics							
Input Capacitance	C_{iss}	$V_{DS} = 50V, V_{GS} = 0V, f = 1MHz$	-	3750	-	μF	
Output Capacitance	C_{oss}		-	471	-		
Reverse Transfer Capacitance	C_{rss}		-	12	-		
Switching Characteristics							
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	-	2.2	-	Ω	
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 60V, I_D = 20A$	-	43	-	nC	
Gate-Source Charge	Q_{gs}		-	7.7	-		
Gate-Drain Charge	Q_{gd}		-	6.7	-		
Turn-on Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 60V, R_G = 10\Omega, I_D = 20A$	-	14.3	-	ns	
Rise Time	t_r		-	7.8	-		
Turn-off Delay Time	$t_{d(off)}$		-	29	-		
Fall Time	t_f		-	8.6	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ²	V_{SD}	$I_S = 20A, V_{GS} = 0V$	-	-	1.2	V	
Continuous Source Current ^{1,5}	I_S	$V_G = V_D = 0V$, Force Current	-	-	90	A	
Reverse Recovery Time	t_{rr}	$V_R = 60V, I_F = 20A, di_F/dt = 500A/\mu s$	-	46	-	ns	
Reverse Recovery Charge	Q_{rr}		-	278	-	nC	

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD} = 50V, V_{GS} = 10V, L = 0.4mH, I_{AS} = 29A$
4. The power dissipation is limited by 150°C junction temperature
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

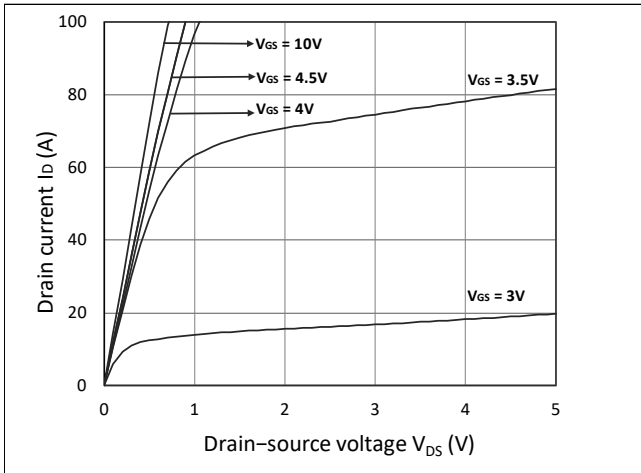


Figure 1. Output Characteristics

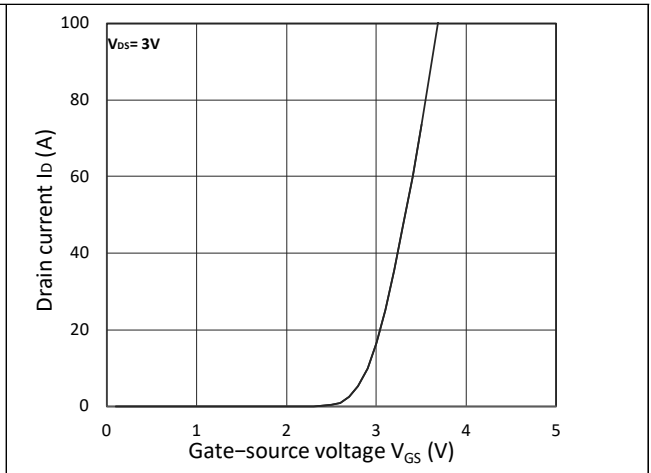


Figure 2. Transfer Characteristics

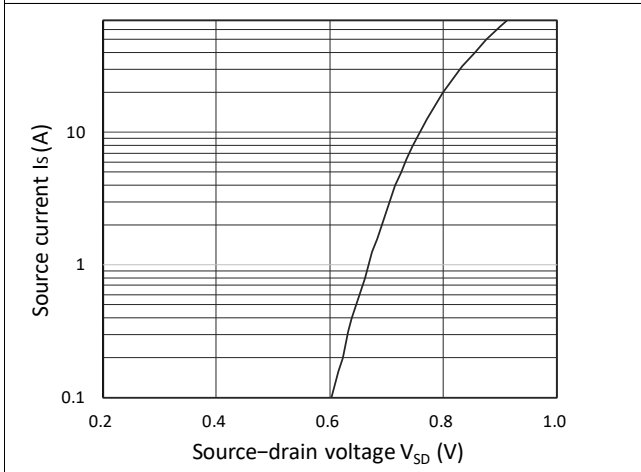


Figure 3. Forward Characteristics of Reverse

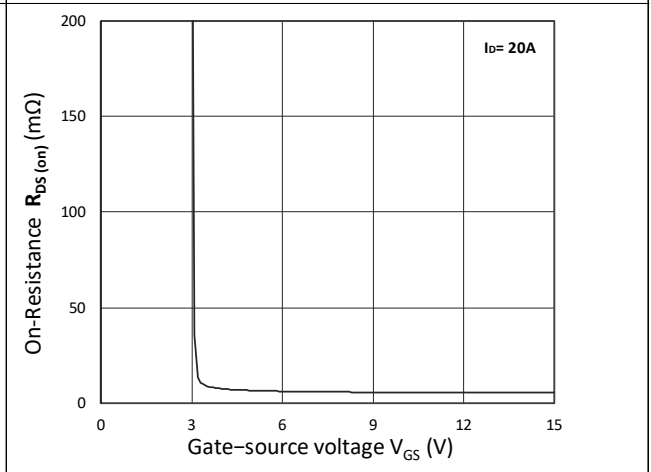


Figure 4. $R_{DS(on)}$ vs. V_{GS}

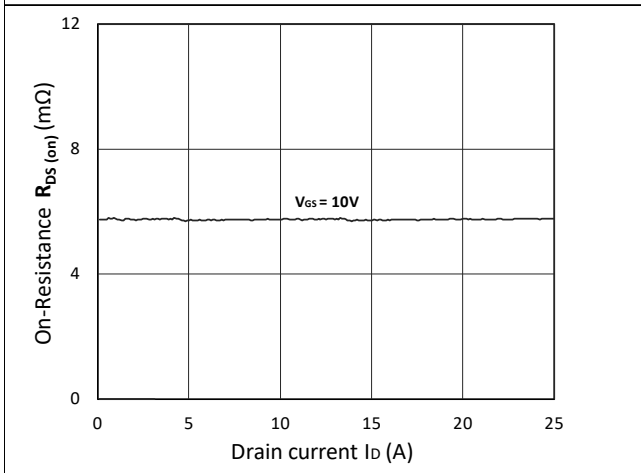


Figure 5. $R_{DS(on)}$ vs. I_D

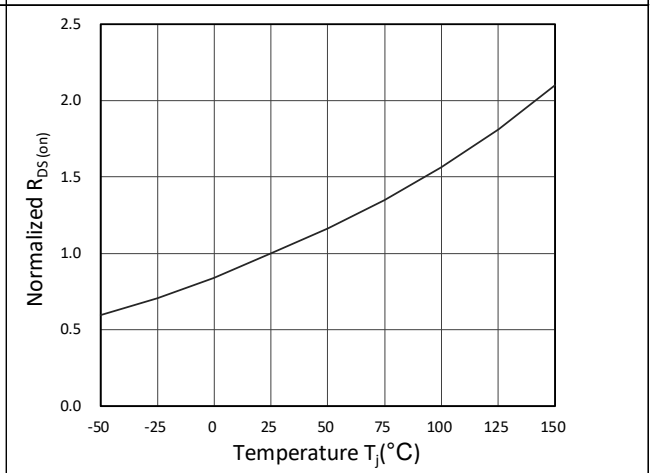


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

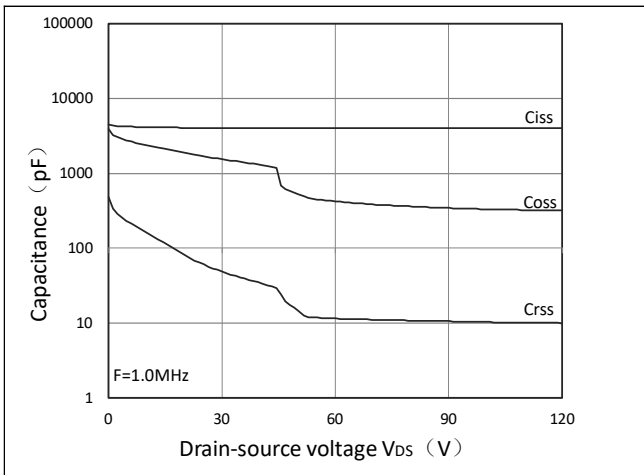


Figure 7. Capacitance Characteristics

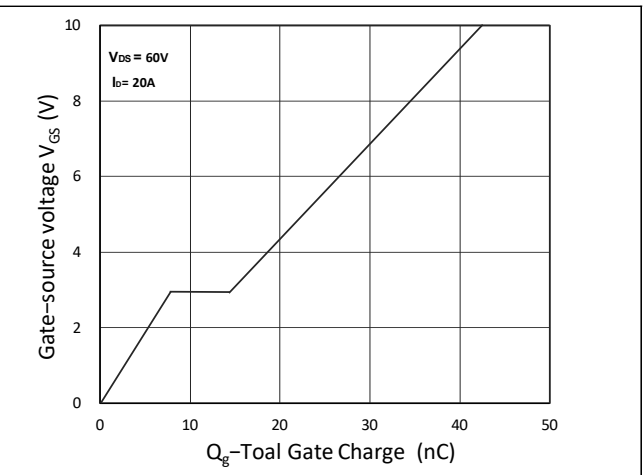


Figure 8. Gate Charge Characteristics

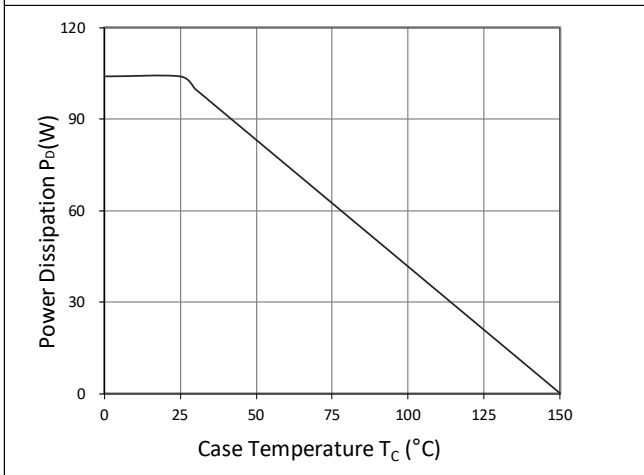


Figure 9. Power Dissipation

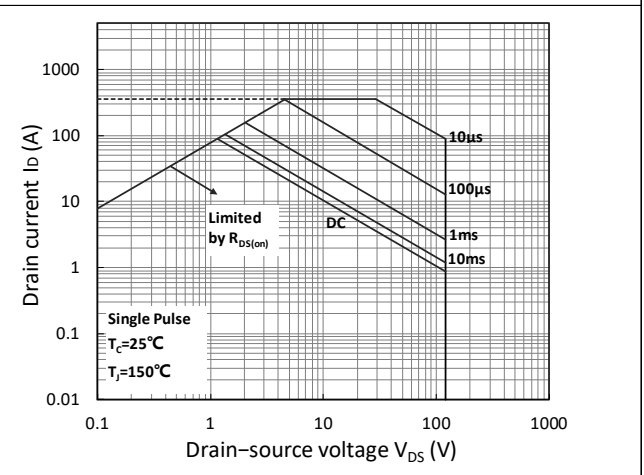


Figure 10. Safe Operating Area

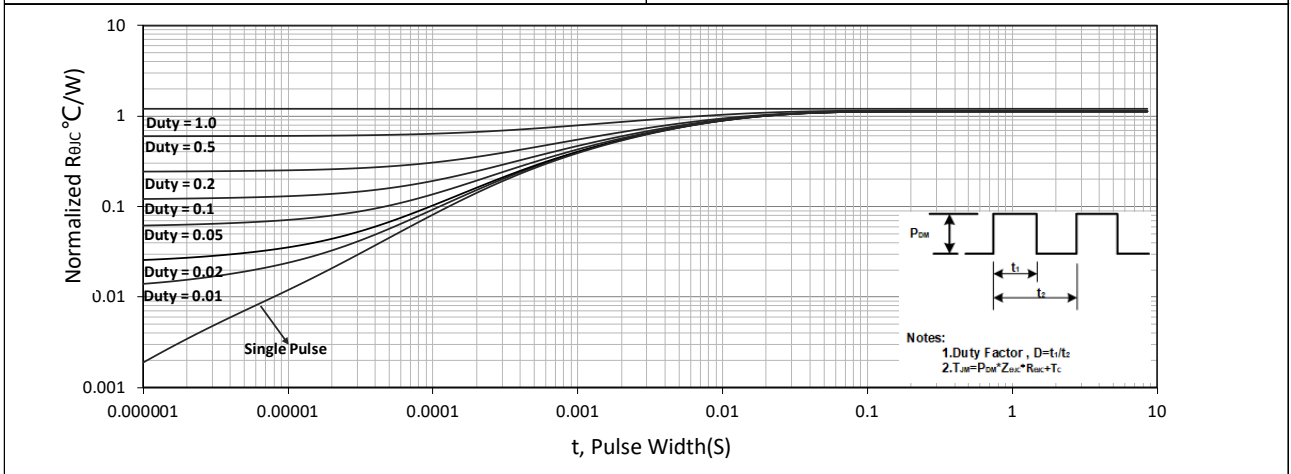


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

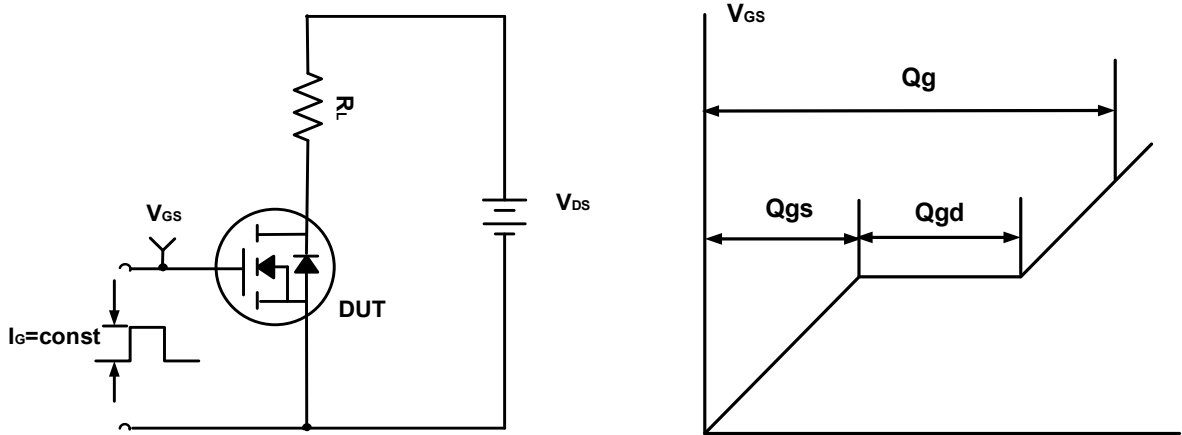


Figure A. Gate Charge Test Circuit & Waveforms

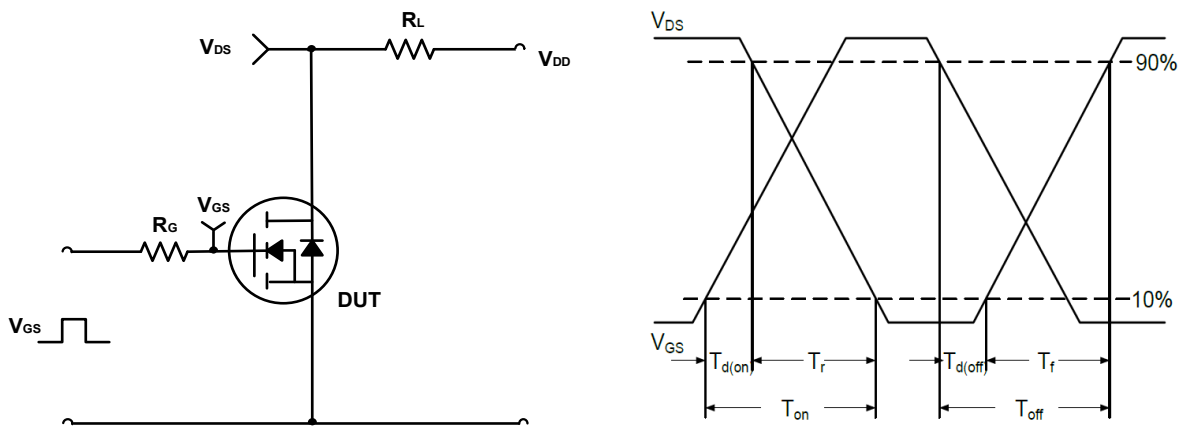


Figure B. Switching Test Circuit & Waveforms

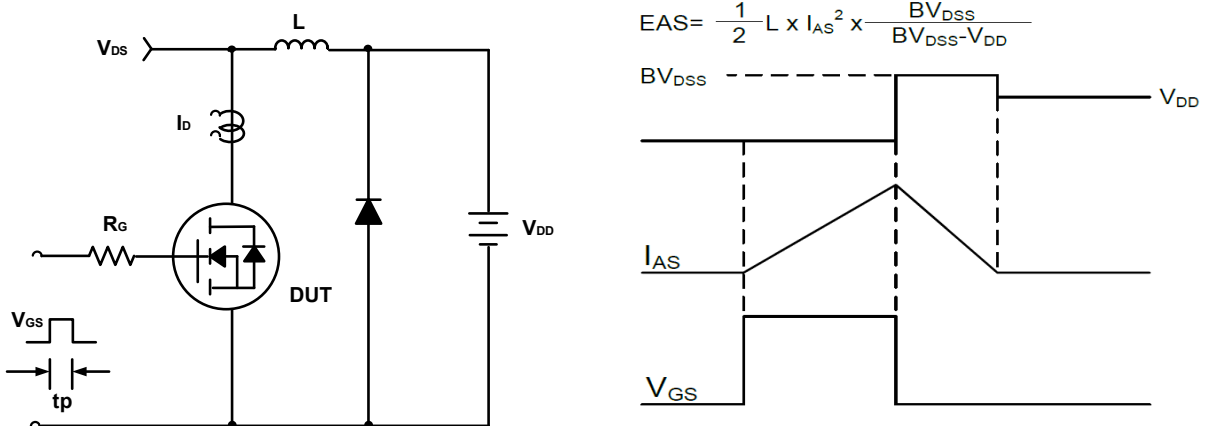
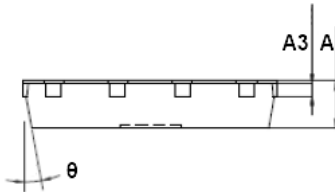
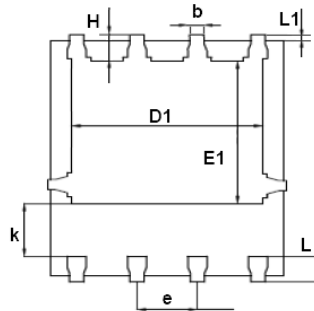
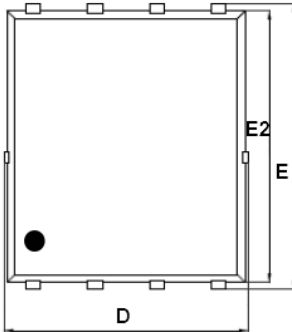


Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for PDFN5060-8L

COMMON DIMENSIONS

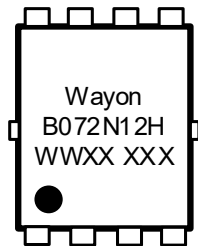


SYMBOL	MM	
	MIN	MAX
A	0.90	1.20
A3	0.15	0.35
D	4.80	5.40
E	5.90	6.35
D1	3.61	4.31
E1	3.30	3.92
E2	5.50	6.06
k	1.10	-
b	0.30	0.51
e	1.27BSC	
L	0.38	0.71
L1	0.05	0.36
H	0.38	0.71
θ	0°	12°

Ordering Information

Part	Package	Marking	Packing method
WMB072N12HG2	PDFN5060-8L	B072N12H	Tape and Reel

Marking Information



B072N12H = Device code

WWXX XXX= Date code


Contact Information

No.1001, Shiwan(7) Road, Pudong District, Shanghai, P.R.China.201207

Tel: 86-21-50310888 Fax: 86-21-50757680 Email: market@way-on.com

WAYON website: <http://www.way-on.com>

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